

BTA203-800ET

3Q Hi-Com Triac Rev.01 - 05 January 2022

Product data sheet

1. General description

Planar passivated high commutation three quadrant triac in a TO92 plastic package intended for use in circuits where high static and dynamic dV/dt and high dI/dt can occur. This series triac will commutate the full rated RMS current at the maximum rated junction temperature without the aid of a snubber.

2. Features and benefits

- 3Q technology for improved noise immunity
- High blocking voltage capability
- High commutation capability with maximum false trigger immunity
- High immunity to false turn-on by dV/dt
- Less sensitive gate for high noise immunity
- · Planar passivated for voltage ruggedness and reliability
- Triggering in three quadrants only

3. Applications

- · General purpose motor control circuits
- Home appliances
- Solenoid drivers

4. Quick reference data

Table 1. Qi	uick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Absolute	maximum rating					
V_{DRM}	repetitive peak off-state voltage	eak off-state		-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; Fig. 1; Fig. 2; Fig. 3	-	-	3	А
I _{TSM} non-repetitive peak on- state current	full sine wave; t_p = 20 ms; $T_{j(init)}$ = 25 °C Fig. 4; Fig. 5	-	-	27	A	
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C	-	-	30	А
Tj	junction temperature		-	-	150	°C
Static ch	aracteristics	· /				
I _{GT} gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G+} $ T _j = 25 °C; <u>Fig. 7</u>	-	-	10	mA	
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G-} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	10	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G-} T_{j} = 25 \text{ °C}; Fig. 7$	-	-	10	mA
V _T	on-state voltage	I _T = 3 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.2	1.4	V

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Dynamic characteristics							
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}; \text{ T}_{\text{j}} = 125 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit$		500	-	-	V/µs
dI _{com} /dt	rate of change of commutating current	$ V_D = 400 \text{ V}; \text{T}_j = 150 \text{ °C}; \text{I}_{\text{T(RMS)}} = 3 \text{ A}; \\ $		2	-	-	A/ms

5. Pinning information

Table 2. P	able 2. Pinning information						
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	T2	main terminal 2		NI			
2	G	gate					
3	T1	main terminal 1	() () () 3 2 1 TO-92 (SOT54)	g sym051			

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
BTA203-800ET	TO92	BTA203-800ETEP	Bulk	1000	SOT54	14-Nov-2013		
BTA203-800ET	TO92	BTA203-800ETQP	Reel	2000	SOT54 wide pitch	14-Nov-2013		
BTA203-800ET/L01	TO92	BTA203-800ET/L01EP	Bulk	500	SOT54/L01	14-Nov-2013		

7. Marking

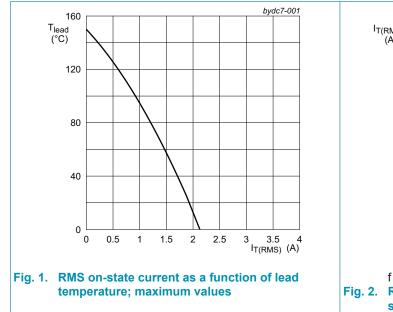
Table 4. Marking codes				
Type number	Marking codes			
BTA203-800ET	203-8E			

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DRM}	repetitive peak off-state voltage			-	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; <u>Fig. 1; Fig. 2; Fig. 3</u>		-	-	3	А
I _{TSM}	non-repetitive peak on- state current	full sine wave; $t_p = 20 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$; Fig. 4; Fig. 5		-	-	27	A
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C		-	-	30	А
l ² t	l ² t for fusing	t _p = 10 ms; sine wave		-	-	3.7	A ² s
dI _T /dt	rate of rise of on-state current	I _G = 20 mA		-	-	100	A/µs
I _{GM}	peak gate current			-	-	2	А
P _{GM}	peak gate power			-	-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period		-	-	0.5	W
T _{stg}	storage temperature			-40	-	150	°C
T _j	junction temperature			-40	-	150	°C



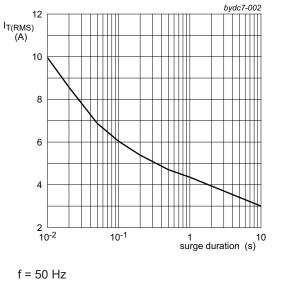
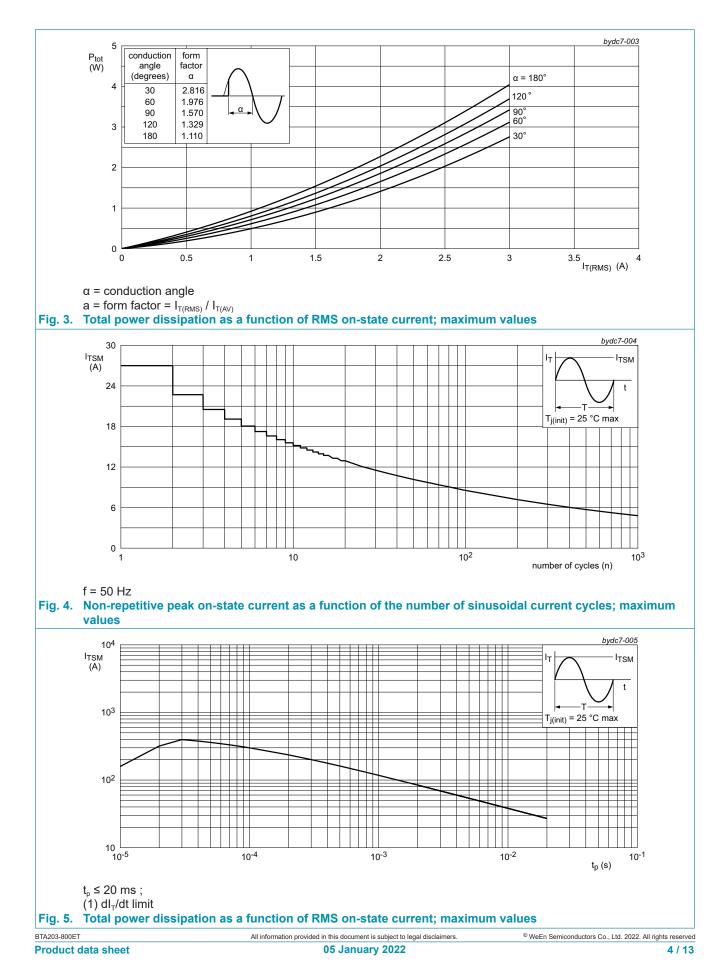


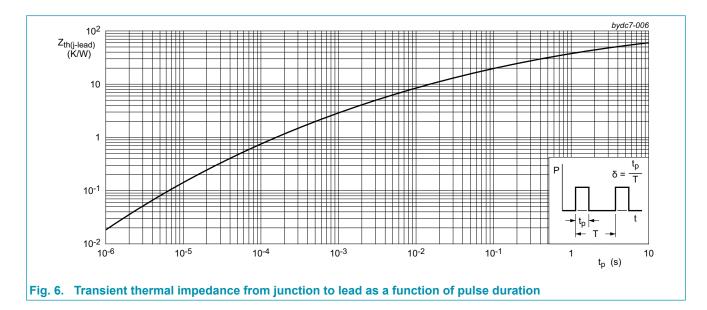
Fig. 2. RMS on-state current as a function of surge duration; maximum values

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9. Thermal characteristics

Table 5. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	<u>Fig. 6</u>	-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	150	-	K/W



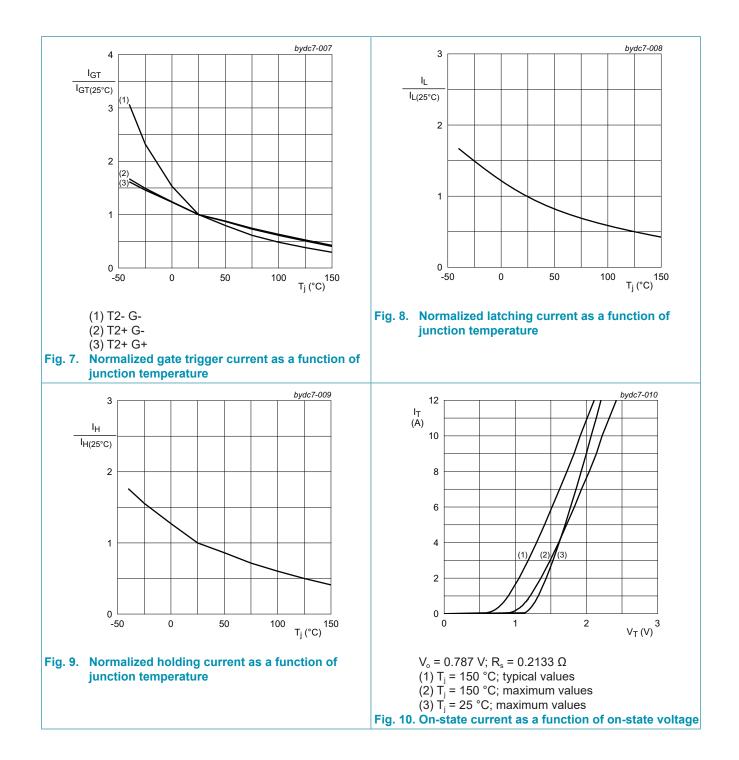
10. Characteristics

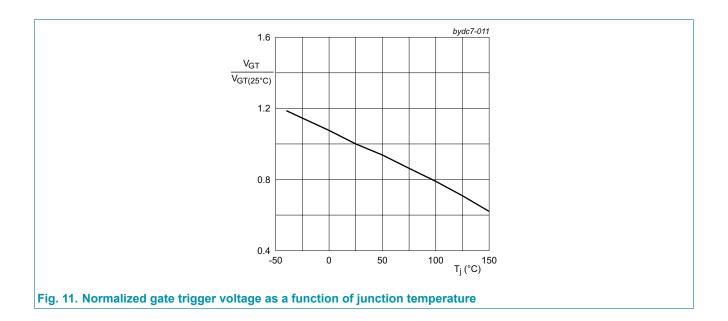
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $\text{T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 7}$	-	-	10	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G-};$ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	10	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G-};$ T _j = 25 °C; Fig. 7	-	-	10	mA
IL	latching current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 8}$	-	-	30	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G-};$ $\text{T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 8}$	-	-	40	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G-};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 8}$	-	-	30	mA mA mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	20	mA
V _T	on-state voltage	I _T = 3 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.2	1.4	V
V_{GT}	gate trigger voltage	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T}_{j} = 25 \text{ °C};$ Fig. 11	-	0.7	1	V
		V _D = 400 V; I _T = 0.1 A; T _j = 150 °C	0.25	0.45	-	V
I _D	off-state current	V _D = 800 V; T _j = 25 °C	-	-	5	μA
		V _D = 800 V; T _j = 150 °C	-	-	0.5	mA
Dynamic o	haracteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 150 \text{ °C}; \text{ I}_{T(RMS)} = 3 \text{ A};$ $dV_{com}/dt = 20 \text{ V/}\mu\text{s}; \text{ (snubberless condition); gate open circuit}$	2	-	-	A/ms

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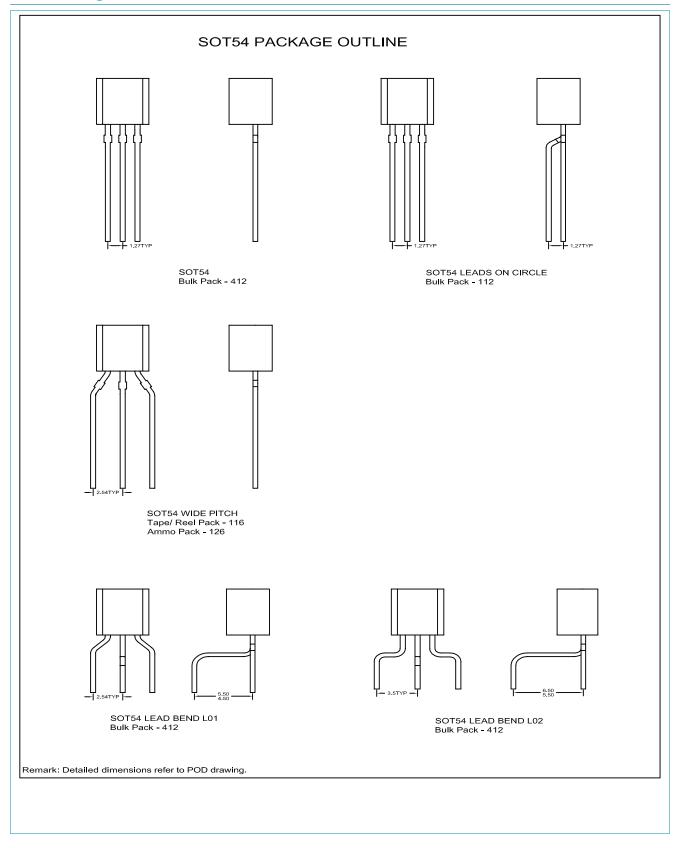
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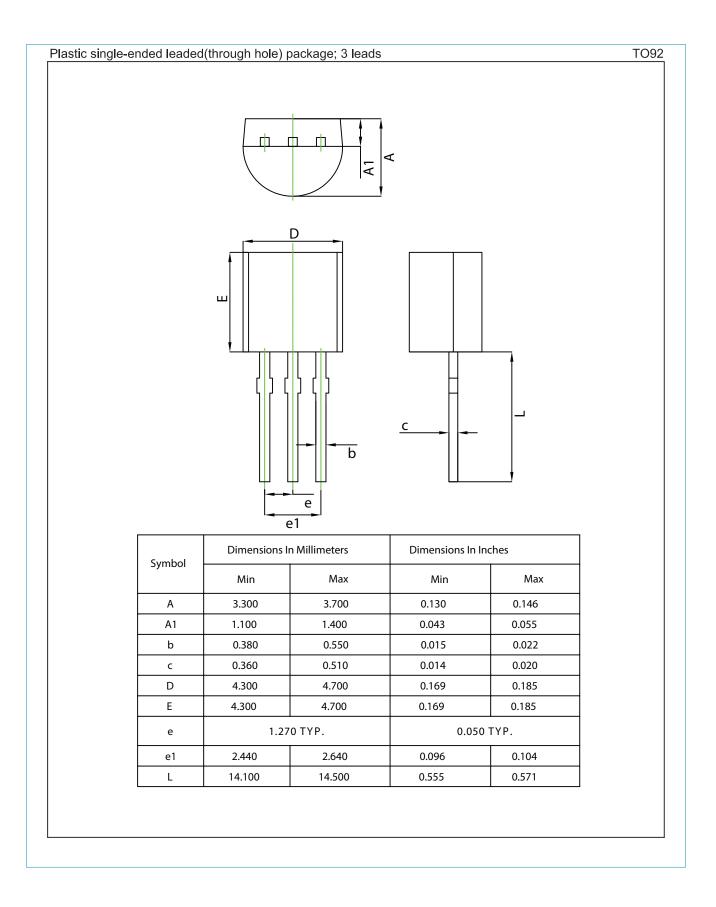




11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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